

Weidmüller Interface GmbH & Co. KG

Klingenbergstraße 26 D-32758 Detmold Germany

www.weidmueller.com

























High-temperature-resistant pin header, packed in box or tape. On tape, with 1.5 mm solder pin, optimised for automatic assembly. 3.2 mm solder pin suitable for reflow and wave soldering. The pin headers provide space for labelling and can be coded. HC = High Current.

General ordering data

Version	PCB plug-in connector, male header, Flange, THT/ THR solder connection, 5.08 mm, Number of poles: 2, 90°, Solder pin length (I): 3.2 mm, tinned, black, Box	
Order No.	<u>1837630000</u>	
Туре	SL-SMT 5.08HC/02/90F 3.2SN BK BX	
GTIN (EAN)	4032248347445	
Qty.	90 pc(s).	
Product data	IEC: 400 V / 27.5 A UL: 300 V / 18.5 A	
Packaging	Box	

Creation date March 25, 2021 3:15:46 PM CET



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Technical data

Dimensions and weights

Depth	12 mm	Depth (inches)	0.472 inch
Height	11.7 mm	Height (inches)	0.461 inch
Height of lowest version	8.5 mm	Net weight	1.894 g
Width	20.32 mm	Width (inches)	0.8 inch

System specifications

Product family	OMNIMATE Signal - series BL/SL 5.08	8		
Type of connection	Board connection			
Mounting onto the PCB	THT/THR solder connection			
Pitch in mm (P)	5.08 mm			
Pitch in inches (P)	0.2 inch			
Outgoing elbow	90°			
Number of poles	2			
Number of solder pins per pole	1			
Solder pin length (I)	3.2 mm			
Solder pin length tolerance	0 / -0.3 mm			
Solder pin dimensions	d = 1.2 mm, Octagonal			
Solder eyelet hole diameter (D)	1.5 mm			
Solder eyelet hole diameter tolerand	e (D)+ 0,1 mm			
L1 in mm	5.08 mm			
L1 in inches	0.2 inch			
Number of rows	1			
Pin series quantity	1			
Volume resistance	≤5 mΩ			
Can be coded	Yes			
Plugging force/pole, max.	9 N			
Pulling force/pole, max.	7 N			
Tightening torque	Torque type	Mounting screw, PCB		
	Usage information	Tightening torque	min.	0.15 Nm
			max.	0.2 Nm
		Recommended screw	Part	PTSC KA
			number	2.2X4.5
				<u>WN1412</u>

Material data

Insulating material	LCP GF	Colour	black
Colour chart (similar)	RAL 9011	Insulating material group	Illa
Comparative Tracking Index (CTI)	≥ 175	Moisture Level (MSL)	1
UL 94 flammability rating	V-0	Contact material	CuMg
Contact surface		Layer structure of solder connection	13 µm Ni / 24 µm Sn
	tinned		matt
Layer structure of plug contact	13 μm Ni / 24 μm Sn	Storage temperature, min.	
	matt		-40 °C
Storage temperature, max.	70 °C	Operating temperature, min.	-50 °C
Operating temperature, max.	100 °C	Temperature range, installation, min.	-30 °C
Temperature range, installation, max.	100 °C		



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40 mm 180 mm

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Technical data

Rated data acc. to IEC

tested acc. to standard		Rated current, min. number of poles	
	IEC 60664-1, IEC 61984	(Tu=20°C)	27.5 A
Rated current, max. number of poles		Rated current, min. number of poles	
(Tu=20°C)	19 A	(Tu=40°C)	24 A
Rated current, max. number of poles		Rated voltage for surge voltage class /	
(Tu=40°C)	16.5 A	pollution degree II/2	400 V
Rated voltage for surge voltage class /		Rated voltage for surge voltage class /	
pollution degree III/2	320 V	pollution degree III/3	250 V
Rated impulse voltage for surge voltage		Rated impulse voltage for surge voltage	
class/ pollution degree II/2	4 kV	class/ pollution degree III/2	4 kV
Rated impulse voltage for surge voltage			
class/ contamination degree III/3	4 kV		

Rated data acc. to CSA

Institute (CSA)		Certificate No. (CSA)	
			200039-1176845
Rated voltage (Use group B / CSA)	300 V	Rated voltage (Use group D / CSA)	300 V
Rated current (Use group B / CSA)	18.5 A	Rated current (Use group D / CSA)	18.5 A
Reference to approval values	Specifications are maximum values, details - see approval certificate.		

Rated data acc. to UL 1059

Institute (UR)	<i>27</i> 7.	Certificate No. (UR)	
			E60693
Rated voltage (Use group B / UL 1059)	300 V	Rated voltage (Use group D / UL 1059)	300 V
Rated current (Use group B / UL 1059)	18.5 A	Rated current (Use group D / UL 1059)	10 A
Reference to approval values	Specifications are maximum values, details - see approval certificate.		

Packaging

VPE width

Classifications

ETIM 6.0	EC002637	ETIM 7.0	EC002637
ECLASS 9.0	27-44-04-02	ECLASS 9.1	27-44-04-02
ECLASS 10.0	27-44-04-02	ECLASS 11.0	27-46-02-01

VPE length

VPE height

Box

60 mm



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Important note

IPC conformity	Conformity: The products are developed, manufactured and delivered according international recognized standards and norms and comply with the assured properties in the data sheet resp. fulfill decorative properties in accordance with IPC-A-610 "Class 2". Further claims on the products can be evaluated on request.
Notes	Gold-plated contact surfaces on request
	Rated current related to rated cross-section & min. No. of poles.
	• Diameter of solder eyelet D = 1.4+0.1mm
	• Solder eyelet diameter D = 1.5 + 0.1 mm, from 9 poles
	• P on drawing = pitch
	 Rated data refer only to the component itself. Clearance and creepage distances to other components are to be designed in accordance with the relevant application standards.
	• Long term storage of the product with average temperature of 50 °C and average humidity 70%, 36 months

Approvals



ROHS	Conform
UL File Number Search	E60693

Downloads

Approval/Certificate/Document of	
Conformity	Declaration of the Manufacturer
Engineering Data	<u>STEP</u>
Engineering Data	WSCAD



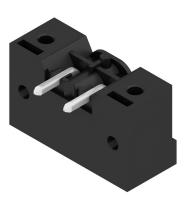
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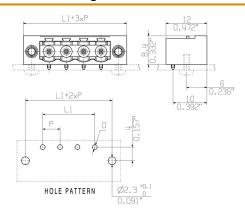
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Drawings

Product image



Dimensional drawing



Product benefits



Safe power transmission Proven properties

D = 1.4/0.055" or 1.5/0.059" (REFLOW SOLDERING)

standard, and are valid for its field of application.
Provided that the components are used to the intended purpose, all requirements with respect to the occuring of electrical, mechanical, thermic and corrosive stress will be satisfied.

shown: SL-SMT 5.08HC/04/90F

		0	00.0
		7	30.4
4.5	0.1/-0.3	6	25.4
		5	20.3
3.2	0.1/-0.3	4	15.2
2.1	0.1/-0.3	3	10.1
1.5	-0.3	2	5.08
		H-	1.1
1	tolerance	no of poles	[mm

	9	40.64	1.600	
	8	35.56	1.400	
	7	30.48	1.200	
٦	6	25.40	1.000	
1	5	20.32	0.800	+/- 0.1
$\frac{1}{2}$	4	15.24	0.600	
1	3	10.16	0.400	
	2	5.08	0.200	
	no of poles	L1 [mm]	L1 [inch]	tolerance L1

DIN ISO 2768-m RoHS

106339/4 30.07.18 HERTEL_S Weidmüller 🐔



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Cat.no.:.

Drawing no. Issue no Sheet 04 sheets

	Modification		
		Date	Name
	Drawn	29.11.2007	HELIS_MA
	Responsible		HERTEL_S
Scale: 2:1	Checked	01.08.2018	KOCH_JG
Supersedes: .	Approved		LANG_T

SL-SMT 5.08HC/../90... STIFTLEISTE MALE HEADER

Product file: SL-SMT 5.08

7280

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Recommended wave solderding profiles

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Single Wave:



Double Wave:



Wave soldering profiles

Wired connection elements should be processed in accordance with the DIN EN 61760-1 standard. We have included two recommendations for practical wave soldering profiles, with which Weidmüller PCB terminals and connectors are qualified.

When choosing a suitable profile for your application, the following factors also need to be considered:

- PCB thickness
- Proportion of Cu in the layers
- Single/double-sided assembly
- Product range
- Heating and cooling rates

The single and double wave profiles each indicate the recommended operating range, including the maximum soldering temperature of 260°C. In practice, the maximum soldering temperature is quite often well below the above maximum profile.



Recommended reflow soldering profile

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Reflow soldering profile

The perfect soldering profile for SMT Surface Mount Technology is one the most exiting question in SMT production. But there are more than one correct answer: The diagram of temperature-on-time is related to processing features of solder paste and to maximum load of components.

We have to consider the following parameters:

- · Time for pre heating
- Maximum temperature
- Time above melting point
- · Time for cooling
- · Maximum heating rate
- Maximum cooling rate

We recommend a typical solder profile with associated process limits. With preheating components and board are prepared smoothly for the solder phase. Heating rate is typically $\leq +3$ K/s. In parallel the solder paste is ,activated'. The time above melting point of 217°C the paste gets liquid and components and boards begin to connect. The maximum temperature of 245°C to 254°C should stay between 10 and 40 seconds. In the cooling phase at \geq -6K/s solder is cured. Board and components cool down while avoiding cold cracks.